

Call for Technical Demonstrations
ACM International Conference on Multimedia
Pan Pacific Hotel, Vancouver, BC, Canada
October 27 – November 1, 2008

http://www.mcrlab.uottawa.ca/acmmm2008/

ACM Multimedia 2008 invites you to submit a technical demo. Technical Demos should demonstrate leading edge work in any area of multimedia technology and its application.

Submissions are particularly encouraged in the areas of haptics, smell, sensors, novel interface design, 3D multimedia and immersive technologies, wireless multimedia applications, multimedia-based security applications, digital rights management, multimedia databases, content analysis, content-based retrieval, multimedia storage, multimedia networking, media processing, entertainment, compression, hypermedia authoring, multimedia social networking and innovative applications.

Each submission should consist of a 2 page paper (which will be included in the proceedings if accepted) and a presentation/video. Please zip all files into one, and add the EDAS number at the end of the file name before uploading it. The paper should be prepared in double-column ACM proceedings style, and use PDF for the documents. The two files should be packed into one using zip for upload where each file is named using the assigned EDAS paper number. The submission should be registered and the zip'ed file uploaded through EDAS . More submission instructions are available here.

All submissions will be peer-reviewed to ensure quality. An award will be given for the best technical demonstration, as judged by an evaluation panel. Demonstrators will be provided with space and access to a local network (but the demo should not rely on the Internet access). The participants will be required to provide their own computing equipment and any additional network, display, haptic, sensor, etc., hardware needed for the demonstration

Key Dates

June 6, 2008 Submission deadline
June 27, 2008 Notification of acceptance
August 1, 2008 Final camera ready version

Contacts

Please direct any questions regarding technical demonstrations to the co-chairs: Anup Basu (Univ. of Alberta, Canada)
Pål Halvorsen (Univ. of Oslo, Norway)

Program Committee

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